

# LM2524D/LM3524D Regulating Pulse Width Modulator

### **General Description**

The LM3524D family is an improved version of the industry standard LM3524. It has improved specifications and additional features yet is pin for pin compatible with existing 3524 families. New features reduce the need for additional external circuitry often required in the original version.

The LM3524D has a  $\pm 1\%$  precision 5V reference. The current carrying capability of the output drive transistors has been raised to 200 mA while reducing  $V_{CEsat}$  and increasing  $V_{CE}$  breakdown to 60V. The common mode voltage range of the error-amp has been raised to 5.5V to eliminate the need for a resistive divider from the 5V reference.

In the LM3524D the circuit bias line has been isolated from the shut-down pin. This prevents the oscillator pulse amplitude and frequency from being disturbed by shut-down. Also at high frequencies ( 300 kHz) the max. duty cycle per output has been improved to 44% compared to 35% max. duty cycle in other 3524s.

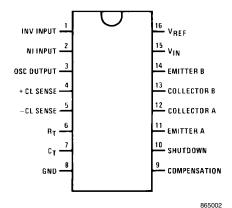
In addition, the LM3524D can now be synchronized externally, through pin 3. Also a latch has been added to insure one

pulse per period even in noisy environments. The LM3524D includes double pulse suppression logic that insures when a shut-down condition is removed the state of the T-flip-flop will change only after the first clock pulse has arrived. This feature prevents the same output from being pulsed twice in a row, thus reducing the possibility of core saturation in push-pull designs.

### **Features**

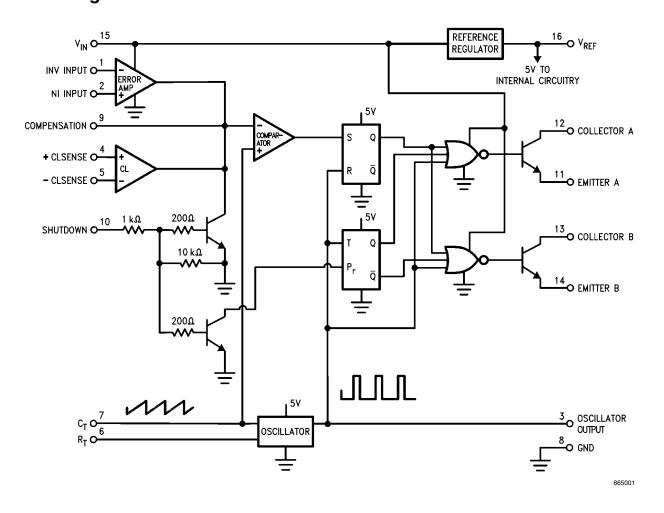
- Fully interchangeable with standard LM3524 family
- ±1% precision 5V reference with thermal shut-down
- Output current to 200 mA DC
- 60V output capability
- Wide common mode input range for error-amp
- One pulse per period (noise suppression)
- Improved max. duty cycle at high frequencies
- Double pulse suppression
- Synchronize through pin 3

### **Connection Diagram**



Top View
Order Number LM2524DN or LM3524DN
See NS Package Number N16E
Order Number LM3524DM
See NS Package Number M16A

# **Block Diagram**



### **Absolute Maximum Ratings** (Note 5)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Supply Voltage 40V

Collector Supply Voltage

(LM2524D) 55V (LM3524D) 40V

Output Current DC (each) 200 mA

Oscillator Charging Current (Pin 7) 5 mA

1W Internal Power Dissipation **Operating Junction Temperature** 

Range (Note 2)

-40°C to +125°C LM2524D LM3524D 0°C to +125°C

Maximum Junction Temperature 150° Storage Temperature Range -65°C to +150°C

Lead Temperature (Soldering 4 sec.)

M, N Pkg. 260°C

### **Electrical Characteristics**

(Note 1)

Symbol	Parameter	Conditions	LM2524D			LM3524D			
			Tested		Design		Tested	Design	Units
			Тур	Limit	Limit	Тур	Limit	Limit	
				(Note 3)	(Note 4)		(Note 3)	(Note 4)	
REFERENC	E SECTION		<u>,                                      </u>						•
V <sub>REF</sub>	Output Voltage		5	4.85	4.80	5	4.75		V <sub>Min</sub>
				5.15	5.20	]	5.25		V <sub>Max</sub>
V <sub>RLine</sub>	Line Regulation	V <sub>IN</sub> = 8V to 40V	10	15	30	10	25	50	mV <sub>Max</sub>
V <sub>RLoad</sub>	Load Regulation	I <sub>L</sub> = 0 mA to 20 mA	10	15	25	10	25	50	mV <sub>Max</sub>
$\frac{\Delta V_{IN}}{\Delta V_{REF}}$	Ripple Rejection	f = 120 Hz	66			66			dB
l <sub>os</sub>	Short Circuit	V <sub>REF</sub> = 0		25			25		mA Min
	Current		50			50			
				180			200		mA Max
N <sub>O</sub>	Output Noise	10 Hz ≤ f ≤ 10 kHz	40		100	40		100	μV <sub>rms Max</sub>
	Long Term	T <sub>A</sub> = 125°C	20			20			mV/kHr
	Stability								
OSCILLATO	OR SECTION								-
f <sub>osc</sub>	Max. Freq.	$R_T = 1k, C_T = 0.001 \mu F$ (Note 7)	550		500	350			kHz <sub>Min</sub>
f <sub>osc</sub>	Initial	$R_T = 5.6k, C_T = 0.01 \mu F$		17.5			17.5		kHz <sub>Min</sub>
	Accuracy	(Note 7)	20			20			
				22.5			22.5		kHz <sub>Max</sub>
		$R_T = 2.7k$ , $C_T = 0.01 \mu F$		34			30		kHz <sub>Min</sub>
		(Note 7)	38			38			
				42			46		kHz <sub>Max</sub>
Δf <sub>OSC</sub>	Freq. Change with V <sub>IN</sub>	V <sub>IN</sub> = 8 to 40V	0.5	1		0.5	1.0		% <sub>Max</sub>
$\Delta f_{OSC}$	Freq. Change	$T_A = -55^{\circ}C \text{ to } +125^{\circ}C$							
	with Temp.	at 20 kHz $R_T = 5.6k$ ,	5			5			%
		C <sub>T</sub> = 0.01 μF							
V <sub>OSC</sub>	Output Amplitude	$R_T = 5.6k, C_T = 0.01 \mu\text{F}$	3	2.4		3	2.4		V <sub>Min</sub>
	(Pin 3) (Note 8)	1 7 1							l wiii!
t <sub>PW</sub>	Output Pulse	$R_T = 5.6k, C_T = 0.01 \mu\text{F}$	0.5	1.5		0.5	1.5		μs <sub>Max</sub>
	Width (Pin 3)	1 7 1 2 2 12							I IVIAX
	Sawtooth Peak	$R_T = 5.6k, C_T = 0.01 \mu\text{F}$	3.4	3.6	3.8		3.8		V <sub>Max</sub>
	Voltage	1 , -1		-			-		IVIAX

			LM2524D				LM3524	D	I
Symbol	Parameter	Conditions		Tested	Design		Tested	Design	Units
			Тур	Limit	Limit	Тур	Limit	Limit	
				(Note 3)	(Note 4)		(Note 3)	(Note 4)	
	Sawtooth Valley	$R_T = 5.6k, C_T = 0.01 \mu F$	1.1	0.8	0.6		0.6		$V_{Min}$
	Voltage								
ERROR-AM	P SECTION	!			<u>!</u>				
V <sub>IO</sub>	Input Offset	V <sub>CM</sub> = 2.5V	2	8	10	2	10		mV <sub>Ma</sub>
•10	Voltage	V CM = 2.0 V	-	Ü	10	_	10		··· • Ma
I <sub>IB</sub>	Input Bias	V <sub>CM</sub> = 2.5V	1	8	10	1	10		
'IB	1	V <sub>CM</sub> - 2.3V	'	0	10	'	10		μA <sub>Ma</sub>
	Current	N/ 0.51/	<del> </del>						_
I <sub>IO</sub>	Input Offset Current	V <sub>CM</sub> = 2.5V	0.5	1.0	1	0.5	1		μA <sub>Ma</sub>
1		\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\		65			65		
I <sub>COSI</sub>	Compensation	$V_{IN(I)} - V_{IN(NI)} = 150 \text{ mV}$		65			05		μA <sub>Mii</sub>
	Current (Sink)		95	405		95	405		
				125			125		μA <sub>Ma</sub>
I <sub>coso</sub>	Compensation	$V_{IN(NI)} - V_{IN(I)} = 150 \text{ mV}$		-125			-125		$\mu A_{Min}$
	Current (Source)		-95			-95			
				-65			-65		$\mu A_{Ma}$
A <sub>VOL</sub>	Open Loop Gain	$R_L = \infty, V_{CM} = 2.5 \text{ V}$	80	74	60	80	70	60	dB <sub>Mir</sub>
VCMR	Common Mode	L OIN		1.5	1.4		1.5		V <sub>Min</sub>
	Input Voltage			5.5	5.4		5.5		V <sub>Max</sub>
	Range			0.0	•••		0.0		· Max
CMRR	Common Mode		90	80		90	80		dB <sub>Mir</sub>
	Rejection Ratio								IVIII
G <sub>BW</sub>	Unity Gain	$A_{VOL} = 0 \text{ dB}, V_{CM} = 2.5V$	3			2			MHz
O-BW	Bandwidth	TAVOL G GE, TOM EIGT				_			
V <sub>O</sub>	Output Voltage	R₁ = ∞		0.5			0.5		V <sub>Min</sub>
•0		In <sub>L</sub> = ∞							
	Swing	1/ 0 / 40/		5.5			5.5		V <sub>Max</sub>
PSRR	Power Supply	V <sub>IN</sub> = 8 to 40V	80		70	80	65		db <sub>Mir</sub>
	Rejection Ratio								
COMPARAT	TOR SECTION	1							
ton	Minimum Duty	Pin 9 = 0.8V,	0	0		0	0		% <sub>Max</sub>
tosc	Cycle	$[R_T = 5.6k, C_T = 0.01 \mu F]$							
ton	Maximum Duty	Pin 9 = 3.9V,	49	45		49	45		% <sub>Min</sub>
tosc	Cycle	$[R_T = 5.6k, C_T = 0.01 \mu F]$							
	Maximum Duty	Pin 9 = 3.9V,	44	35		44	35		% <sub>Min</sub>
$\frac{t_{ON}}{t_{OSC}}$	Cycle			33			00		∕ <sup>o</sup> Min
		$[R_T = 1k, C_T = 0.001 \mu\text{F}]$							
$V_{COMPZ}$	Input Threshold	Zero Duty Cycle	1			1			V
	(Pin 9)					<u> </u>			
V <sub>COMPM</sub>	Input Threshold	Maximum Duty Cycle	3.5			3.5			V
	(Pin 9)								
I <sub>IB</sub>	Input Bias		-1			-1			μΑ
	Current								
CURRENT	LIMIT SECTION								
V <sub>SEN</sub>	Sense Voltage	V <sub>(Pin 2)</sub> − V <sub>(Pin 1)</sub> ≥		180			180		mV <sub>Mi</sub>
		150 mV	200			200			1411
				220			220		$mV_{Ma}$
									····ivla

	Parameter	Conditions		LM2524D			LM3524D		
Symbol				Tested	Design		Tested	Design	Units
			Тур	Limit	Limit	Тур	Limit	Limit	
				(Note 3)	(Note 4)		(Note 3)	(Note 4)	
	Common Mode		-0.7			-0.7			V <sub>Min</sub>
	Voltage Range	$V_5 - V_4 = 300 \text{ mV}$	1			1			V <sub>Max</sub>
SHUT DO	VN SECTION	-			-			× .	
V <sub>SD</sub>	High Input	V <sub>(Pin 2)</sub> − V <sub>(Pin 1)</sub> ≥	1	0.5		1	0.5		$V_{Min}$
	Voltage	150 mV		1.5			1.5		V <sub>Max</sub>
I <sub>SD</sub>	High Input	I <sub>(pin 10)</sub>	1			1			mA
	Current	,							
OUTPUT	ECTION (EACH OU	TPUT)							
V <sub>CES</sub>	Collector Emitter	I <sub>C</sub> ≤ 100 μA		55			40		V <sub>Min</sub>
	Voltage Breakdown								
I <sub>CES</sub>	Collector Leakage	V <sub>CE</sub> = 60V							
	Current	V <sub>CE</sub> = 55V	0.1	50					μA <sub>Ma</sub>
		V <sub>CE</sub> = 40V				0.1	50		
V <sub>CESAT</sub>	Saturation	I <sub>E</sub> = 20 mA	0.2	0.5		0.2	0.7		V <sub>Max</sub>
	Voltage	I <sub>E</sub> = 200 mA	1.5	2.2		1.5	2.5		
V <sub>EO</sub>	Emitter Output	I <sub>E</sub> = 50 mA	18	17		18	17		$V_{Min}$
	Voltage								
t <sub>R</sub>	Rise Time	$V_{IN} = 20V,$							
		I <sub>E</sub> = -250 μA	200			200			ns
		$R_C = 2k$							
t <sub>F</sub>	Fall Time	$R_C = 2k$	100			100			ns
SUPPLY C	HARACTERISTICS S	SECTION							
$V_{IN}$	Input Voltage	After Turn-on		8			8		$V_{Min}$
	Range			40			40		V <sub>Max</sub>
Т	Thermal Shutdown	(Note 2)	160			160			°C
	Temp.								
I <sub>IN</sub>	Stand By Current	V <sub>IN</sub> = 40V (Note 6)	5	10		5	10		mA

Note 1: Unless otherwise stated, these specifications apply for  $T_A = T_J = 25^{\circ}C$ . Boldface numbers apply over the rated temperature range: LM2524D is  $-40^{\circ}$  to  $85^{\circ}C$  and LM3524D is  $0^{\circ}C$  to  $70^{\circ}C$ .  $V_{IN} = 20V$  and  $f_{OSC} = 20$  kHz.

Note 2: For operation at elevated temperatures, devices in the N package must be derated based on a thermal resistance of 86°C/W, junction to ambient. Devices in the M package must be derated at 125°C/W, junction to ambient.

Note 3: Tested limits are guaranteed and 100% tested in production.

Note 4: Design limits are guaranteed (but not 100% production tested) over the indicated temperature and supply voltage range. These limits are not used to calculate outgoing quality level.

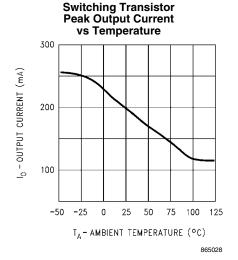
Note 5: Absolute maximum ratings indicate limits beyond which damage to the device may occur. DC and AC electrical specifications do not apply when operating the device beyond its rated operating conditions.

Note 6: Pins 1, 4, 7, 8, 11, and 14 are grounded; Pin 2 = 2V. All other inputs and outputs open.

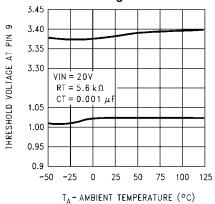
Note 7: The value of a C<sub>1</sub> capacitor can vary with frequency. Careful selection of this capacitor must be made for high frequency operation. Polystyrene was used in this test. NPO ceramic or polypropylene can also be used.

Note 8: OSC amplitude is measured open circuit. Available current is limited to 1 mA so care must be exercised to limit capacitive loading of fast pulses.

# **Typical Performance Characteristics**

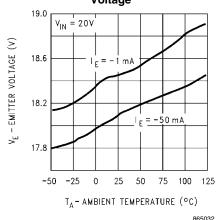




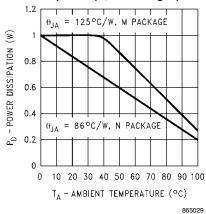


# Output Transistor Emitter Voltage

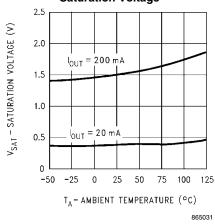
865030



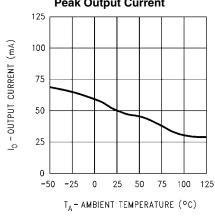
# Maximum Average Power Dissipation (N, M Packages)



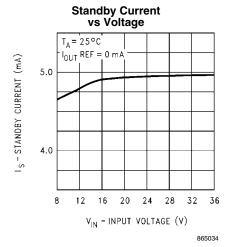
#### Output Transistor Saturation Voltage

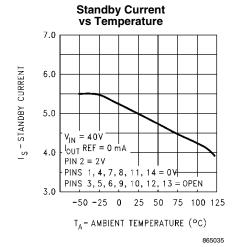


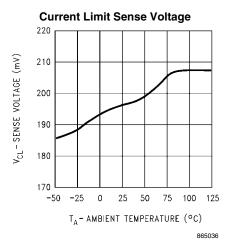
#### Reference Transistor Peak Output Current



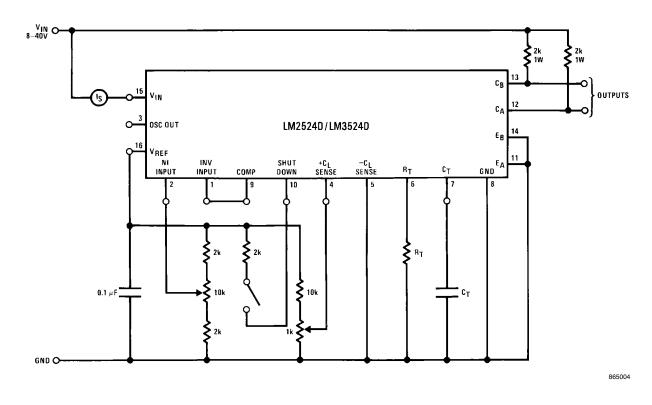
865033







### **Test Circuit**

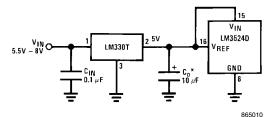


## **Functional Description**

#### INTERNAL VOLTAGE REGULATOR

The LM3524D has an on-chip 5V, 50 mA, short circuit protected voltage regulator. This voltage regulator provides a supply for all internal circuitry of the device and can be used as an external reference.

For input voltages of less than 8V the 5V output should be shorted to pin 15,  $V_{\rm IN}$ , which disables the 5V regulator. With these pins shorted the input voltage must be limited to a maximum of 6V. If input voltages of 6V–8V are to be used, a preregulator, as shown in *Figure 1*, must be added.



\*Minimum Co of 10 µF required for stability.

#### FIGURE 1.

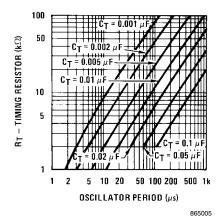
#### **OSCILLATOR**

The LM3524D provides a stable on-board oscillator. Its frequency is set by an external resistor,  $R_T$  and capacitor,  $C_T$ . A graph of  $R_T$ ,  $C_T$  vs oscillator frequency is shown is Figure 2. The oscillator's output provides the signals for triggering an internal flip-flop, which directs the PWM information to the outputs, and a blanking pulse to turn off both outputs during transitions to ensure that cross conduction does not occur. The width of the blanking pulse, or dead time, is controlled by the value of  $C_T$ , as shown in Figure 3. The recommended values of  $R_T$  are 1.8  $k\Omega$  to 100  $k\Omega$ , and for  $C_T$ , 0.001  $\mu F$  to 0.1  $\mu F$ .

If two or more LM3524D's must be synchronized together, the easiest method is to interconnect all pin 3 terminals, tie all pin 7's (together) to a single  $C_{\rm T}$ , and leave all pin 6's open except one which is connected to a single  $R_{\rm T}$ . This method works well unless the LM3524D's are more than 6 apart.

A second synchronization method is appropriate for any circuit layout. One LM3524D, designated as master, must have its  $\rm R_TC_T$  set for the correct period. The other slave LM3524D (s) should each have an  $\rm R_TC_T$  set for a 10% longer period. All pin 3's must then be interconnected to allow the master to properly reset the slave units.

The oscillator may be synchronized to an external clock source by setting the internal free-running oscillator frequency 10% slower than the external clock and driving pin 3 with a pulse train (approx. 3V) from the clock. Pulse width should be greater than 50 ns to insure full synchronization.



#### FIGURE 2.

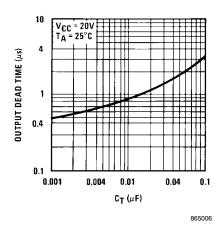


FIGURE 3.

#### **ERROR AMPLIFIER**

The error amplifier is a differential input, transconductance amplifier. Its gain, nominally 86 dB, is set by either feedback or output loading. This output loading can be done with either purely resistive or a combination of resistive and reactive components. A graph of the amplifier's gain vs output load resistance is shown in *Figure 4*.

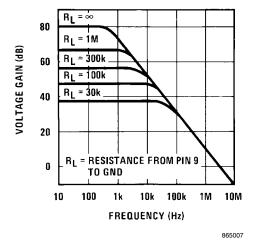


FIGURE 4.

The output of the amplifier, or input to the pulse width modulator, can be overridden easily as its output impedance is very high ( $Z_{\rm O}$  5 M $\Omega$ ). For this reason a DC voltage can be applied to pin 9 which will override the error amplifier and force a particular duty cycle to the outputs. An example of this could be a non-regulating motor speed control where a variable voltage was applied to pin 9 to control motor speed. A graph of the output duty cycle vs the voltage on pin 9 is shown in *Figure 5*.

The duty cycle is calculated as the percentage ratio of each output's ON-time to the oscillator period. Paralleling the outputs doubles the observed duty cycle.

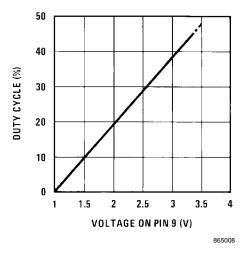


FIGURE 5.

The amplifier's inputs have a common-mode input range of 1.5V–5.5V. The on board regulator is useful for biasing the inputs to within this range.

#### **CURRENT LIMITING**

The function of the current limit amplifier is to override the error amplifier's output and take control of the pulse width. The output duty cycle drops to about 25% when a current limit sense voltage of 200 mV is applied between the  $+C_L$  and  $-C_L$ sense terminals. Increasing the sense voltage approximately 5% results in a 0% output duty cycle. Care should be taken to ensure the -0.7V to +1.0V input common-mode range is not exceeded.

In most applications, the current limit sense voltage is produced by a current through a sense resistor. The accuracy of this measurement is limited by the accuracy of the sense resistor, and by a small offset current, typically 100  $\mu A$ , flowing from +CL to –CL.

#### **OUTPUT STAGES**

The outputs of the LM3524D are NPN transistors, capable of a maximum current of 200 mA. These transistors are driven 180° out of phase and have non-committed open collectors and emitters as shown in *Figure 6*.

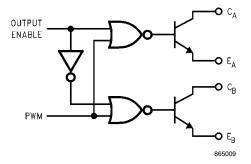
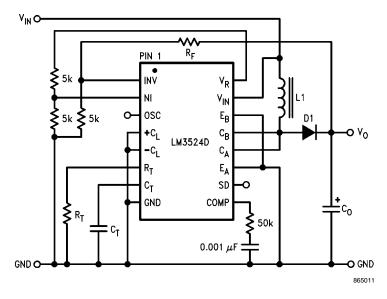


FIGURE 6.

# **Typical Applications**



#### **Design Equations**

$$R_F = 5k \left( \frac{V_0}{2.5} - 1 \right)$$

$$\begin{split} f_{OSC} &\cong \frac{1}{R_T C_T} \\ L1 &= \frac{2.5 V_{IN}^2 \left(V_O - V_{IN}\right)}{f_{OSC} l_O \, V_O^2} \\ C_o &= \frac{l_O \left(V_O - V_{IN}\right)}{f_{OSC} \, \Delta V_O \, V_O} \\ l_{o(MAX)} &= l_{IN} \frac{V_{IN}}{V_O} \end{split}$$

FIGURE 7. Positive Regulator, Step-Up Basic Configuration ( $I_{IN(MAX)} = 80 \text{ mA}$ )

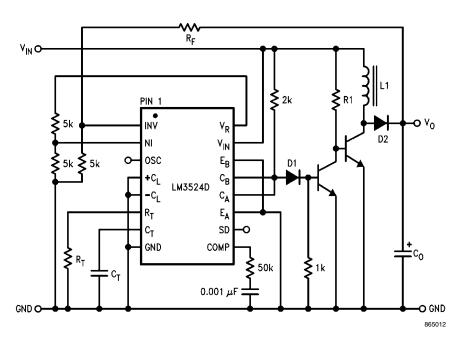
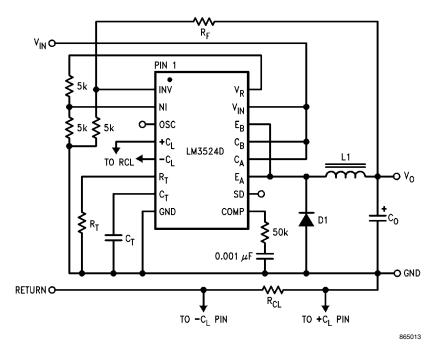


FIGURE 8. Positive Regulator, Step-Up Boosted Current Configuration



#### Design Equations

$$\begin{split} R_F &= 5 \, \text{k}\Omega \left( \frac{\text{V}_o}{2.5} - 1 \right) \\ R_{CL} &= \frac{\text{Current Limit}}{\text{I}_{O(MAX)}} \\ f_{OSC} &\simeq \frac{1}{R_T C_T} \\ L1 &= \frac{2.5 \text{V}_o \, (\text{V}_{IN} - \text{V}_o)}{\text{I}_o \, \text{V}_{IN} \, \text{f}_{OSC}} \\ C_o &= \frac{(\text{V}_{IN} - \text{V}_o) \, \text{V}_o \text{T}^2}{8 \, \Delta \, \text{V}_o \, \text{V}_{IN} \text{L}} \\ I_{O(MAX)} &= I_{IN} \frac{\text{V}_{IN}}{\text{V}_o} \end{split}$$

FIGURE 9. Positive Regulator, Step-Down Basic Configuration ( $I_{IN(MAX)} = 80 \text{ mA}$ )

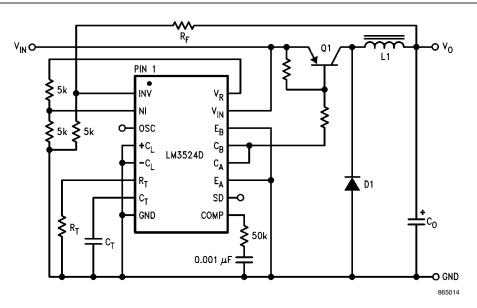
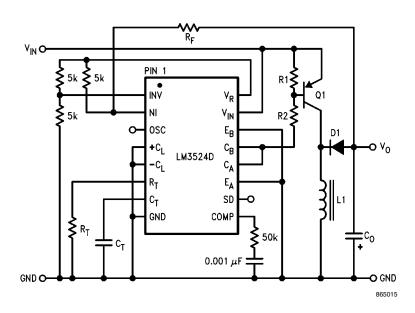


FIGURE 10. Positive Regulator, Step-Down Boosted Current Configuration



#### **Design Equations**

$$R_{F} = 5k \left(1 - \frac{V_{o}}{2.5}\right)$$

$$f_{OSC} \approx \frac{1}{R_{T}C_{T}}$$

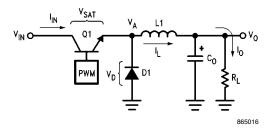
$$L1 = \frac{2.5V_{IN} V_{o}}{f_{OSC} (V_{o} + V_{IN}) I_{o}}$$

$$C_{o} = \frac{I_{o}V_{o}}{\Delta V_{o} f_{OSC} (V_{o} + V_{IN})}$$

FIGURE 11. Boosted Current Polarity Inverter

# BASIC SWITCHING REGULATOR THEORY AND APPLICATIONS

The basic circuit of a step-down switching regulator circuit is shown in *Figure 12*, along with a practical circuit design using the LM3524D in *Figure 15*.



The circuit works as follows: Q1 is used as a switch, which has ON and OFF times controlled by the pulse width modulator. When Q1 is ON, power is drawn from  $V_{\rm IN}$  and supplied to the load through L1;  $V_{\rm A}$  is at approximately  $V_{\rm IN}$ , D1 is reverse biased, and  $C_{\rm o}$  is charging. When Q1 turns OFF the inductor L1 will force  $V_{\rm A}$  negative to keep the current flowing in it, D1 will start conducting and the load current will flow through D1 and L1. The voltage at  $V_{\rm A}$  is smoothed by the L1,  $C_{\rm o}$  filter giving a clean DC output. The current flowing through L1 is equal to the nominal DC load current plus some  $\Delta I_{\rm L}$  which is due to the changing voltage across it. A good rule of thumb is to set  $\Delta I_{\rm LP-P}-40\%\times I_{\rm o}$ .

FIGURE 12. Basic Step-Down Switching Regulator

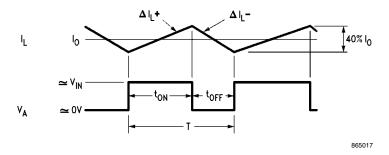


FIGURE 13. Relation of Switch Timing to Inductor Current in Step-Down Regulator

From the relation 
$$V_L = L \frac{d_i}{d_t}$$
,  $\Delta I_L \cong \frac{V_L T}{L1}$ 

$$\Delta I_L^+ = \frac{(V_{IN} - V_O) t_{ON}}{L1}; \Delta I_L^- = \frac{V_O t_{OFF}}{L1}$$

Neglecting  $V_{SAT}$ ,  $V_{D}$ , and settling  $\Delta I_{L}^{+} = \Delta I_{L}^{-}$ ;

$$\boxed{ V_{\text{O}} \cong V_{\text{IN}} \left( \frac{t_{\text{ON}}}{t_{\text{OFF}} + t_{\text{ON}}} \right) = V_{\text{IN}} \left( \frac{t_{\text{ON}}}{T} \right); }$$

where T = Total Period

The above shows the relation between  $V_{\rm IN}, V_{\rm o}$  and duty cycle.

$$I_{IN(DC)} = I_{OUT(DC)} \left( \frac{t_{ON}}{t_{ON} + t_{OFF}} \right),$$

as Q1 only conducts during ton.

$$P_{IN} = I_{IN(DC)} V_{IN} = (I_{o(DC)}) \left( \frac{t_{ON}}{t_{ON} + t_{OFF}} \right) V_{IN}$$

$$P_{o} = I_{o}V_{o}$$

The efficiency, n, of the circuit is:

$$\begin{split} \eta \text{MAX} &= \frac{P_o}{P_{IN}} = \frac{I_o V_o}{I_o \frac{(t_{ON})}{T} V_{IN} + \frac{(V_{SAT} \, t_{ON} + V_{D1} t_{OFF})}{T} I_o} \\ &= \boxed{\frac{V_o}{V_o + 1}} \text{for } V_{SAT} = V_{D1} = 1 V. \end{split}$$

 $\eta$ MAX will be further decreased due to switching losses in Q1. For this reason Q1 should be selected to have the maximum possible  $f_T$ , which implies very fast rise and fall times.

#### **CALCULATING INDUCTOR L1**

$$\begin{split} t_{ON} & \cong \frac{(\Delta I_L^+) \times L1}{(V_{IN} - V_o)}, t_{OFF} = \frac{(\Delta I_L^-) \times L1}{V_o} \\ t_{ON} + t_{OFF} & = T = \frac{(\Delta I_L^+) \times L1}{(V_{IN} - V_Q)} + \frac{(\Delta I_L^-) \times L1}{V_o} \\ & = \frac{0.4 I_o L1}{(V_{IN} - V_o)} + \frac{0.4 I_o L1}{V_o} \end{split}$$

Since  $\Delta I_L + = \Delta I_L^- = 0.4I_o$ Solving the above for L1

$$L1 = \frac{2.5 \, V_o \, (V_{IN} - V_o)}{I_o \, V_{IN} \, f}$$

where: L1 is in Henrys f is switching frequency in Hz

Also, see LM1578 data sheet for graphical methods of inductor selection.

#### CALCULATING OUTPUT FILTER CAPACITOR Co:

Figure 13 shows L1's current with respect to Q1's  $t_{ON}$  and  $t_{OFF}$  times ( $V_A$  is at the collector of Q1). This curent must flow to the load and  $C_o$ .  $C_o$ 's current will then be the difference between  $I_L$ , and  $I_o$ .

$$Ic_0 = I_1 - I_0$$

From Figure 13 it can be seen that current will be flowing into  $C_o$  for the second half of  $t_{ON}$  through the first half of  $t_{OFF}$ , or a time,  $t_{ON}/2 + t_{OFF}/2$ . The current flowing for this time is  $\Delta I_L/4$ . The resulting  $\Delta V_c$  or  $\Delta V_o$  is described by:

$$\begin{split} \Delta V_{op\text{-}p} &= \frac{1}{C} \times \frac{\Delta I_L}{4} \times \left(\frac{t_{ON}}{2} + \frac{t_{OFF}}{2}\right) \\ &= \frac{\Delta I_L}{4C} \left(\frac{t_{ON} + t_{OFF}}{2}\right) \\ \text{Since } \Delta I_L &= \frac{V_o(T - t_{ON})}{L1} \text{ and } t_{ON} = \frac{V_oT}{V_{IN}} \\ \Delta V_{op\text{-}p} &= \frac{V_o\left(T - \frac{V_oT}{V_{IN}}\right)}{4C \; L1} \left(\frac{T}{2}\right) = \frac{(V_{IN} - V_o) \; V_oT^2}{8V_{IN}C_oL1} \text{ or } \\ C_o &= \frac{(V_{IN} - V_o) \; V_o \; T^2}{8\Delta V_oV_{IN}L1} \end{split}$$

where: C is in farads, T is  $\frac{1}{\text{switching frequency}}$   $\Delta V_0$  is p-p output ripple

For best regulation, the inductor's current cannot be allowed to fall to zero. Some minimum load current  $I_o$ , and thus inductor current, is required as shown below:

$$I_{O(MIN)} = \frac{(V_{IN} - V_{O}) t_{ON}}{2L1} = \boxed{\frac{(V_{IN} - V_{O}) V_{O}}{2fV_{IN}L1}}$$

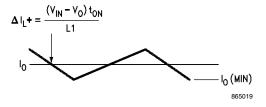


FIGURE 14. Inductor Current Slope in Step-Down Regulator

A complete step-down switching regulator schematic, using the LM3524D, is illustrated in *Figure 15*. Transistors Q1 and Q2 have been added to boost the output to 1A. The 5V regulator of the LM3524D has been divided in half to bias the error amplifier's non-inverting input to within its common-mode range. Since each output transistor is on for half the period, actually 45%, they have been paralleled to allow longer possible duty cycle, up to 90%. This makes a lower possible input voltage. The output voltage is set by:

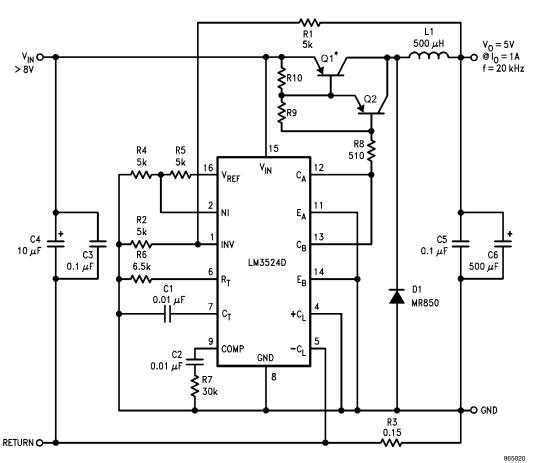
$$V_{o} = V_{NI} \left( 1 + \frac{R1}{R2} \right),$$

where  $\mathbf{V}_{\mathrm{NI}}$  is the voltage at the error amplifier's non-inverting input.

Resistor R3 sets the current limit to:

$$\frac{200 \text{ mV}}{\text{R3}} = \frac{200 \text{ mV}}{0.15} = 1.3 \text{A}.$$

Figures 16, 17 and show a PC board layout and stuffing diagram for the 5V, 1A regulator of Figure 15. The regulator's performance is listed in Table 1.



\*Mounted to Staver Heatsink No. V5-1.

Q1 = BD344

Q2 = 2N5023

L1 = >40 turns No. 22 wire on Ferroxcube No. K300502 Torroid core.

FIGURE 15. 5V, 1 Amp Step-Down Switching Regulator

TABLE 1.

Parameter	Conditions	Typical
		Characteristics
Output Voltage	$V_{IN} = 10V, I_{o} = 1A$	5V
Switching Frequency	$V_{IN} = 10V, I_{o} = 1A$ $V_{IN} = 10V, I_{o} = 1A$ $V_{IN} = 10V$	20 kHz
Short Circuit	$V_{IN} = 10V$	1.3A
Current Limit		
Load Regulation	$V_{IN} = 10V$	3 mV
	$I_0 = 0.2 - 1A$	
Line Regulation	$V_{IN} = 10V$ $I_{o} = 0.2 - 1A$ $\Delta V_{IN} = 10 - 20V$ ,	6 mV
	I <sub>o</sub> = 1A	
Efficiency	$V_{IN} = 10V, I_{o} = 1A$	80%
Output Ripple	$V_{IN} = 10V, I_{o} = 1A$ $V_{IN} = 10V, I_{o} = 1A$	10 mVp-p

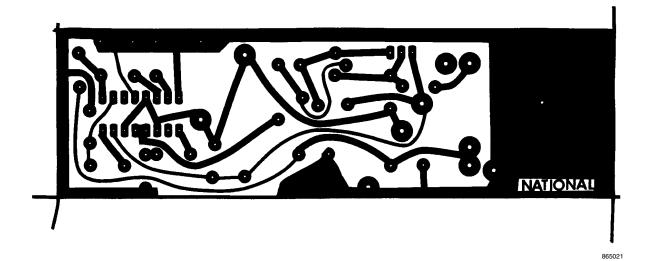


FIGURE 16. 5V, 1 Amp Switching Regulator, Foil Side

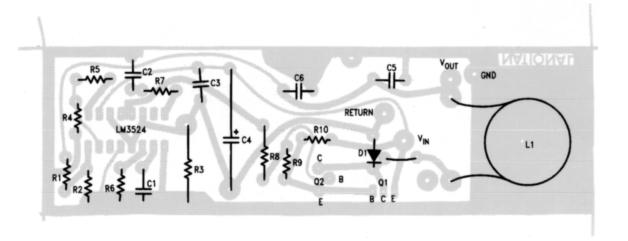


FIGURE 17. Stuffing Diagram, Component Side

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#### THE STEP-UP SWITCHING REGULATOR

Figure 18 shows the basic circuit for a step-up switching regulator. In this circuit Q1 is used as a switch to alternately apply  $V_{IN}$  across inductor L1. During the time,  $t_{ON}$ , Q1 is ON and energy is drawn from  $V_{IN}$  and stored in L1; D1 is reverse biased and  $I_o$  is supplied from the charge stored in  $C_o$ . When Q1 opens,  $t_{OFF}$ , voltage V1 will rise positively to the point where D1 turns ON. The output current is now supplied through L1, D1 to the load and any charge lost from  $C_o$  during  $t_{ON}$  is replenished. Here also, as in the step-down regulator, the current through L1 has a DC component plus some  $\Delta I_L$ .  $\Delta I_L$  is again selected to be approximately 40% of  $I_L$ . Figure 19 shows the inductor's current in relation to Q1's ON and OFF times

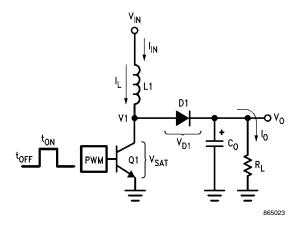


FIGURE 18. Basic Step-Up Switching Regulator

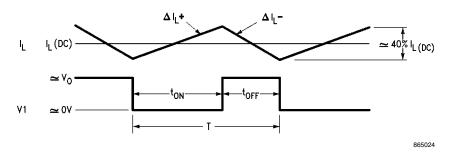


FIGURE 19. Relation of Switch Timing to Inductor Current in Step-Up Regulator

From 
$$\Delta I_L = \frac{V_L T}{L}$$
,  $\Delta I_L + \cong \frac{V_{IN} t_{ON}}{L1}$   
and  $\Delta I_L - \cong \frac{(V_O - V_{IN}) t_{OFF}}{L1}$ 

Since  $\Delta I_L$ + =  $\Delta I_L$ -,  $V_{IN}t_{ON}$  =  $V_ot_{OFF}$  -  $V_{IN}t_{OFF}$ , and neglecting  $V_{SAT}$  and  $V_{D1}$ 

$$V_0 \cong V_{IN} \left(1 + \frac{t_{ON}}{t_{OFF}}\right)$$

The above equation shows the relationship between  $\rm V_{IN}, \ V_{o}$  and duty cycle.

In calculating input current  $I_{\text{IN(DC)}},$  which equals the inductor's DC current, assume first 100% efficiency:

$$\begin{split} P_{IN} &= I_{IN(DC)} \, V_{IN} \\ P_{OUT} &= I_{0} V_{0} = I_{0} \, V_{IN} \left( 1 + \frac{t_{ON}}{t_{OFF}} \right) \end{split} \label{eq:pinout}$$

for 
$$\eta$$
 = 100%,  $P_{OUT}$  =  $P_{IN}$ 

$$I_{O} V_{IN} \left( 1 + \frac{t_{ON}}{t_{OFF}} \right) = I_{IN(DC)} V_{IN}$$
$$I_{IN(DC)} = I_{O} \left( 1 + \frac{t_{ON}}{t_{OFF}} \right)$$

This equation shows that the input, or inductor, current is larger than the output current by the factor (1 +  $t_{ON}/t_{OFF}$ ). Since this factor is the same as the relation between  $V_o$  and  $V_{IN}$ ,  $I_{IN}$  (DC) can also be expressed as:

$$I_{IN(DC)} = I_{o} \left( \frac{V_{o}}{V_{IN}} \right)$$

So far it is assumed  $\eta=100\%,$  where the actual efficiency or  $\eta_{MAX}$  will be somewhat less due to the saturation voltage of Q1 and forward on voltage of D1. The internal power loss due to these voltages is the average  $I_L$  current flowing, or  $I_{IN},$  through either  $V_{SAT}$  or  $V_{D1}.$  For  $V_{SAT}=V_{D1}=1V$  this power loss becomes  $I_{IN(DC)}$  (1V).  $\eta_{MAX}$  is then:

$$\eta_{\text{MAX}} = \frac{P_0}{P_{\text{IN}}} = \frac{V_0 I_0}{V_0 I_0 + I_{\text{IN}} (1V)} = \frac{V_0 I_0}{V_0 I_0 + I_0 \left(1 + \frac{t_{0N}}{t_{0FF}}\right)}$$

From 
$$V_0 = V_{IN} \left(1 + \frac{t_{ON}}{t_{OFF}}\right)$$
 
$$\eta_{max} = \frac{V_{IN}}{V_{IN} + 1}$$

This equation assumes only DC losses, however  $\eta_{\text{MAX}}$  is further decreased because of the switching time of Q1 and D1.

In calculating the output capacitor  $C_o$  it can be seen that  $C_o$  supplies  $I_o$  during  $t_{ON}$ . The voltage change on  $C_o$  during this time will be some  $\Delta V_c = \Delta V_o$  or the output ripple of the regulator. Calculation of  $C_o$  is:

$$\begin{split} \Delta V_O &= \frac{l_O t_{ON}}{C_O} \text{ or } C_O = \frac{l_O t_{ON}}{\Delta V_O} \\ \text{From } V_O &= V_{IN} \left( \frac{T}{t_{OFF}} \right); t_{OFF} = \frac{V_{IN}}{V_O} T \\ \text{where } T &= t_{ON} + t_{OFF} = \frac{1}{f} \\ t_{ON} &= T - \frac{V_{IN}}{V_O} T = T \left( \frac{V_O - V_{IN}}{V_O} \right) \text{ therefore:} \\ C_O &= \frac{I_O T \left( \frac{V_O - V_{IN}}{V_O} \right)}{\Delta V_O} = \boxed{\frac{I_O \left( V_O - V_{IN} \right)}{f \Delta V_O V_O}} \end{split}$$

where:  $C_0$  is in farads, f is the switching frequency,  $\Delta V_0$  is the p-p output ripple Calculation of inductor L1 is as follows:

$$\mbox{L1} = \frac{\mbox{V}_{\mbox{IN}}\mbox{t}_{\mbox{ON}}}{\mbox{\Delta I}_{\mbox{L}}{}^{+}}\mbox{, since during t}_{\mbox{ON}}\mbox{,}$$

V<sub>IN</sub> is applied across L1

$$\begin{split} \Delta I_{Lp\text{-}p} &= 0.4 \ I_L = 0.41 \ I_{IN} = 0.4 \ I_o \left(\frac{V_o}{V_{IN}}\right) \text{, therefore:} \\ L1 &= \frac{V_{IN}t_{ON}}{0.4 \ I_o \left(\frac{V_o}{V_{IN}}\right)} \text{ and since } t_{ON} = \frac{T \ (V_o - V_{IN})}{V_o} \\ \hline \\ L1 &= \frac{2.5 \ V_{IN}^2 \ (V_o - V_{IN})}{f \ I_o V_o^2} \end{split}$$

where: L1 is in henrys, f is the switching frequency in Hz
To apply the above theory, a complete step-up switching regulator is shown in *Figure 20*. Since V<sub>IN</sub> is 5V, V<sub>REF</sub> is tied to

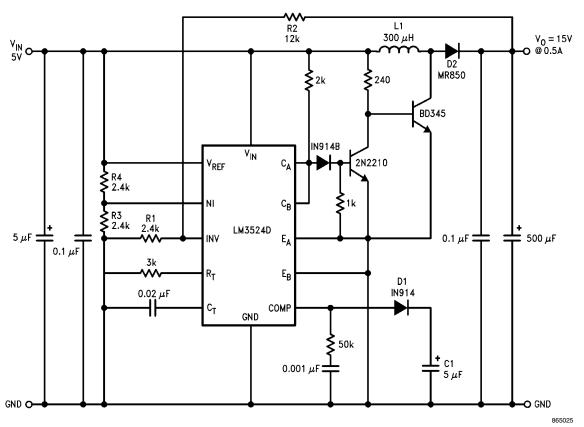
ulator is shown in *Figure 20*. Since  $V_{IN}$  is 5V,  $V_{REF}$  is tied to  $V_{IN}$ . The input voltage is divided by 2 to bias the error amplifier's inverting input. The output voltage is:

$$V_{OUT} = \left(1 + \frac{R2}{R1}\right) \times V_{INV} = 2.5 \times \left(1 + \frac{R2}{R1}\right)$$

The network D1, C1 forms a slow start circuit.

This holds the output of the error amplifier initially low thus reducing the duty-cycle to a minimum. Without the slow start circuit the inductor may saturate at turn-on because it has to supply high peak currents to charge the output capacitor from OV. It should also be noted that this circuit has no supply rejection. By adding a reference voltage at the non-inverting input to the error amplifier, see *Figure 21*, the input voltage variations are rejected.

The LM3524D can also be used in inductorless switching regulators. *Figure 22* shows a polarity inverter which if connected to *Figure 20* provides a –15V unregulated output.



L1 = > 25 turns No. 24 wire on Ferroxcube No. K300502 Toroid core.

FIGURE 20. 15V, 0.5A Step-Up Switching Regulator

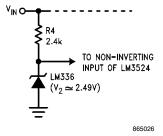


FIGURE 21. Replacing R3/R4 Divider in Figure 20 with Reference Circuit Improves Line Regulation

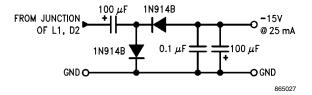
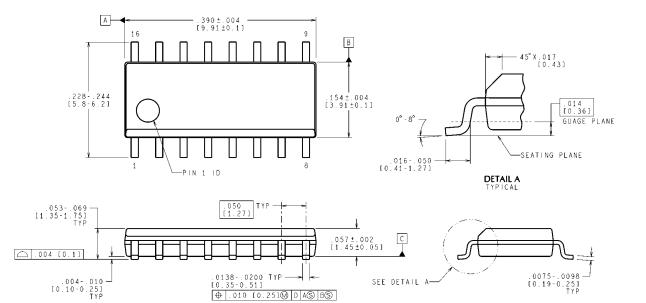


FIGURE 22. Polarity Inverter Provides Auxiliary –15V Unregulated Output from Circuit of Figure 20

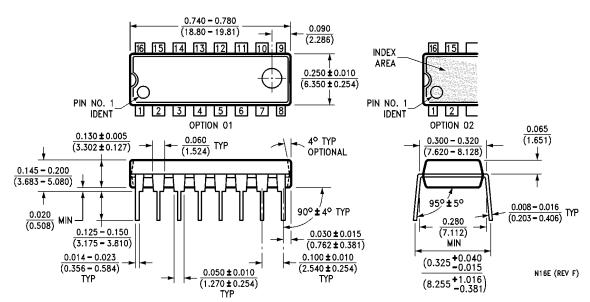
# Physical Dimensions inches (millimeters) unless otherwise noted



CONTROLLING DIMENSION IS INCH VALUES IN [ ] ARE MILLIMETERS

M16A (Rev J)

Molded Surface-Mount Package (M) Order Number LM3524DM NS Package Number M16A



Molded Dual-In-Line Package (N) Order Number LM2524DN or LM3524DN NS Package Number N16E

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